APPLICA	BLE STANDA	RD									
	OPERATING TEMPERATURE R.	ANGE	-40 °C TO +125	5 °C		RAGE PERATU	IRE RANC	ŝΕ	-10 °C TO +60	°C ⁽¹⁾	
RATING	VOLTAGE		60 V AC/DC	DC STORAGE HUMIDITY RANGE			RELATIVE HUMIDITY 8	5% M	AX		
	CURRENT	2 A							(NOT DEWED)		
			SPECIF	FICAT	IONS	3					
	ITEM		TEST METHOD				RE	QUI	REMENTS	QT	AT
CONSTRU										_	
GENERAL E	XAMINATION	VISUALLY AND BY MEASURING INSTRUMENT. ACCORDING TO DRAWING. CONFIRMED VISUALLY.								×	×
	C CHARACTE									×	×
	RESISTANCE	1A DC. 10 mΩ MAX .								×	Τ_
	RESISTANCE	10 mV AC MAX, 0.1 mA(DC OR 1000Hz)				10 mΩ MAX.				×	T -
MILLIVOLT LEVEL METHOD INSULATION RESISTANCE		500 V DC.					100 MO, MIN				 _
										×	
VOLTAGE P		1000 V AC FOR 1 min. NO FLASHOVER OR BREAKDOWN.								×	_
	CAL CHARAC		10								
MECHANICAL OPERATION		30 TIMES INSERTIONS AND EXTRACTIONS.				NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	_
VIBRATION		FREQUENCY 20 TO 200Hz (88m/s²)				① NO ELECTRICAL DISCONTINUITY OF 7ΩMIN ,				×	_
		SWEEP TIME 3min.(ROUND TRIP) AT 3h FOR 3 DIRECTIONS.				1μs MIN. ② CONTACT RESISTANCE: 20 mΩ MAX.				×	_
						3 NO E		CRAC	CK AND LOOSENESS OF		
SHOCK		981m/s ² DURATION OF PULSE 6ms AT 3 TIMES			MES	① NO ELECTRICAL DISCONTINUITY OF $7\Omega \text{MIN}$,					_
		FOR 6 DIRECTIONS.				1μs MIN. ② NO DAMAGE, CRACK AND LOOSENESS OF				×	_
LOCK STRE	NCTH	MEASURE BREAK STRENGTH OF THE LOCK BY				PARTS. ① 100N MIN.				×	-
LOOK STILL	Nam	PULLING THE CONNECTOR IN THE MATING DIRECTION.				TOOK WINK.				^	
ENVIRON	MENTAL CHA									1	
DAMP HEAT		EXPOSE	EXPOSED AT 60 °C, 90 ~ 95 %, 96 h.						TANCE: 20 mΩ MAX.	×	T-
(STEADY STATE)						 INSULATION RESISTANCE:100 MΩ MIN. NO DAMAGE, CRACK AND LOOSENESS OF 				×	-
						_	DAMAGE RTS.	<u>:, Un/</u>	ACK AND LOOSENESS OF	×	_
RAPID CHANGE OF TEMPERATURE		TEMPERATURE- $40 \rightarrow ROOM TEMP \rightarrow 125^{\circ}C \rightarrow ROOM TEMP$ TIME $30 \rightarrow 5 \rightarrow 30 \rightarrow 5 min$			 CONTACT RESISTANCE: 20 mΩ MAX. NO DAMAGE, CRACK AND LOOSENESS OF PARTS. 				×	_	
DRY HEAT			1000 CYCLES. ED AT 140°C, 120 h.			① COI	NTACT R	ESIS	TANCE: 20 mΩ MAX.	×	+_
COLD						NO DAMAGE, CRACK AND LOOSENESS OF PARTS. ONTACT RESISTANCE: 20 mΩ MAX.					-
										×	T -
COLD		EXPOSED AT -40°C , 120 h.				② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.				×	-
RESISTANCE TO SO ₂ GAS		EXPOSED IN 25 PPM AT 75% MIN FOR 96h.				① CONTACT RESISTANCE: 20 mΩ MAX.					_
RESISTANCE TO		REFLOW TEMP. OVER 260°C , 10sec.				NO PLATING PEELING OF THE TERMINALS,					<u> </u>
SOLDERING HEAT SOLDERABILITY		PREHEAT 180°CMAX , 120sec. SOLDERED AT SPECIFIED TEMPERATURE				MELTINGS OF HOUSINGS. A NEW UNIFORM COATING OF SOLDER					-
SOLDLITADI	LIII	PROFILE.			-	SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.				×	
COUN	IT DES	CRIPTION	N OF REVISIONS	_	DESIG	SNED		CHECKED		DA	ATE
<u>/</u> 2\ 1		DIS-T-	-00006017 YH. MA						HH. TSUKUMO	2020	00403
REMARK (NOTE1) "STORAGE" means a long-term s			erm storage state for the unused product				APPRO		HK. UMEHARA		70829
	fore assembly to PCI		rage state for the anaboa produc	•			CHECK DESIGI		HH. TSUKUMO		70829
							DESIG		TY. ISHIGURO MN. SATOH		70829 70829
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DRAWING NO.				ELC-369494-00-00		
100	SPECIFICATION SHEET				PART NO.		ZE05H-2P-2V		ZE05H-2P-2V		
HS	HIRC	SE ELECTRIC CO., LTD.			CODE NO.		CL752-2309-0-00			<u>^</u> 2\	1/1
		·								_	